

CMOS 8-Bit Buffered Multiplying DAC

AD7524

FEATURES

Microprocessor Compatible (6800, 8085, Z80, Etc.)
TTL/CMOS Compatible Inputs
On-Chip Data Latches
Endpoint Linearity
Low Power Consumption
Monotonicity Guaranteed (Full Temperature Range)
Latch Free (No Protection Schottky Required)

APPLICATIONS

Microprocessor Controlled Gain Circuits
Microprocessor Controlled Attenuator Circuits
Microprocessor Controlled Function Generation
Precision AGC Circuits
Bus Structured Instruments

GENERAL DESCRIPTION

The AD7524 is a low cost, 8-bit monolithic CMOS DAC designed for direct interface to most microprocessors.

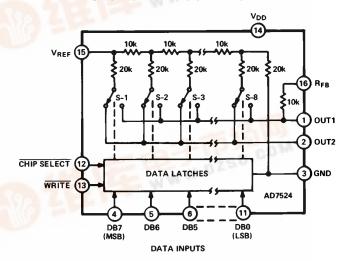
Basically an 8-bit DAC with input latches, the AD7524's load cycle is similar to the "write" cycle of a random access memory. Using an advanced thin-film on CMOS fabrication process, the AD7524 provides accuracy to 1/8 LSB with a typical power dissipation of less than 10 milliwatts.

A newly improved design eliminates the protection Schottky previously required and guarantees TTL compatibility when using a +5 V supply. Loading speed has been increased for compatibility with most microprocessors.

Featuring operation from +5 V to +15 V, the AD7524 interfaces directly to most microprocessor buses or output ports.

Excellent multiplying characteristics (2- or 4-quadrant) make the AD7524 an ideal choice for many microprocessor controlled gain setting and signal control applications.

FUNCTIONAL BLOCK DIAGRAM



ORDERING GUIDE

Model ¹	Temperature Range	Nonlinearity (V _{DD} = +15 V)	Package Option ²
AD7524JN	-40°C to +85°C	±1/2 LSB	N-16
AD7524KN	-40°C to +85°C	±1/4 LSB	N-16
AD7524LN	-40°C to +85°C	±1/8 LSB	N-16
AD7524JP	-40°C to +85°C	$\pm 1/2$ LSB	P-20A
AD7524KP	-40°C to +85°C	$\pm 1/4$ LSB	P-20A
AD7524LP	-40°C to +85°C	$\pm 1/8$ LSB	P-20A
AD7524JR	-40°C to +85°C	$\pm 1/2$ LSB	R-16A
AD7524AQ	-40°C to +85°C	$\pm 1/2$ LSB	Q-16
AD7524BQ	-40°C to +85°C	$\pm 1/4$ LSB	Q-16
AD7524CQ	-40°C to +85°C	$\pm 1/8$ LSB	Q-16
AD7524SQ	-55°C to +125°C	±1/2 LSB	Q-16
AD7524TQ	-55°C to +125°C	±1/4 LSB	Q-16
AD7524UQ	-55°C to +125°C	±1/8 LSB	Q-16
AD7524SE	-55°C to +125°C	$\pm 1/2$ LSB	E-20A
AD7524TE	-55°C to +125°C	±1/4 LSB	E-20A
AD7524UE	-55°C to +125°C	±1/8 LSB	E-20A

NOTES

¹To order MIL-STD-883, Class B processed parts, add/883B to part number. Contact your local sales office for military data sheet. For U.S. Standard Military Drawing (SMD) see DESC drawing #5962-87700.

 2 E = Leadless Ceramic Chip Carrier; N = Plastic DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = SOIC.

$\label{eq:control_loss} AD7524 - SPECIFICATIONS (V_{REF} = +10 \text{ V}, V_{OUT1} = V_{OUT2} = 0 \text{ V}, \text{ unless otherwise noted})$

	Limit.	$T_A = +25^{\circ}C$	Limit.	T _{MIN} , T _{MAX} ¹		
Parameter	$V_{DD} = +5 \text{ V}$	$V_{DD} = +15 \text{ V}$	$V_{DD} = 5 V$	$V_{DD} = +15 \text{ V}$	Units	Test Conditions/Comments
STATIC PERFORMANCE Resolution Relative Accuracy	8	8	8	8	Bits	
J, A, S Versions	±1/2	±1/2	±1/2	±1/2	LSB max	
K, B, T Versions	±1/2	±1/4	±1/2	±1/4	LSB max	
L, C, U Versions	$\pm 1/2$	±1/8	$\pm 1/2$	±1/8	LSB max	
Monotonicity Gain Error ²	Guaranteed ±2 1/2	Guaranteed ±1 1/4	Guaranteed ±3 1/2	Guaranteed ±1 1/2	LSB max	
Average Gain TC ³	±40	±1 1/4 ±10	±3 1/2 ±40	$\begin{array}{c c} \pm 1 & 1/2 \\ \pm 10 \end{array}$	ppm/°C	Gain TC Measured from +25°C to
Tiverage dam 10	_ 10		_ 10		ppin	T _{MIN} or from +25°C to T _{MAX}
DC Supply Rejection, 3 Δ Gain/ Δ V _{DD}	0.08 0.002	0.02 0.001	0.16 0.01	0.04 0.005	% FSR/% max % FSR/% typ	$\Delta V_{DD} = \pm 10\%$
Output Leakage Current	1.50	. 50	. 400			DDO DDZ AV WD GO AV V
I_{OUT1} (Pin 1) I_{OUT2} (Pin 2)	±50 ±50	±50 ±50	±400 ±400	±200 ±200	nA max nA max	$ \begin{array}{c} DB0-DB7=0 \text{ V; } \overline{WR}, \overline{CS}=0 \text{ V; } V_{REF}=\pm 10 \text{ V} \\ DB0-DB7=V_{DD}; \overline{WR}, \overline{CS}=0 \text{ V; } V_{REF}=\pm 10 \text{ V} \end{array} $
	±30	±30	±400	±200	па шах	$DBO-DBI = V_{DD}$; WK, $CS = 0$ V; $V_{REF} = \pm 10$ V
DYNAMIC PERFORMANCE Output Current Settling Time ³ (to 1/2 LSB)	400	250	500	350	ns max	OUT1 Load = 100 Ω , C_{EXT} = 13 pF; \overline{WR} , \overline{CS} = 0 V; DB0-DB7 = 0 V to V_{DD} to 0 V.
AC Feedthrough ³	0.95	0.25	0.5	0.5	% FSR max	V +10 V 100 kHz Sine Wave, DB0 DB7
at OUT1 at OUT2	0.25 0.25	0.25	0.5 0.5	0.5 0.5	% FSR max	$V_{REF} = \pm 10 \text{ V}$, 100 kHz Sine Wave; DB0-DB7 = 0 V ; \overline{WR} , $\overline{CS} = 0 \text{ V}$
REFERENCE INPUT	0.20	0.20	0.0	0.0	70 T BIV IIIUX	0 V, WIG GO = 0 V
R_{IN} (Pin 15 to GND) ⁴	5	5	5	5	kΩ min	
N _{IIV} (Fill To to GIVD)	20	20	20	20	kΩ max	
ANALOG OUTPUTS Output Capacitance ³ C _{OUT1} (Pin 1)	120	120	120	120	pF max	DB0-DB7 = V_{DD} ; \overline{WR} , $\overline{CS} = 0 \text{ V}$
C _{OUT2} (Pin 2)	30	30	30	30	pF max	
C _{OUT1} (Pin 1)	30	30	30	30	pF max	$DB0-DB7 = 0 \text{ V}; \overline{WR}, \overline{CS} = 0 \text{ V}$
C _{OUT2} (Pin 2)	120	120	120	120	pF max	
DIGITAL INPUTS Input HIGH Voltage Requirement	.0.4	. 19.5	. 9. 4	. 10.5	¥7	
V _{IH} Input LOW Voltage Requirement	+2.4	+13.5	+2.4	+13.5	V min	
$V_{\rm IL}$ Input Current	+0.8	+1.5	+0.5	+1.5	V max	
I_{IN}	±1	±1	±10	±10	μA max	$V_{IN} = 0 \text{ V or } V_{DD}$
Input Capacitance ³ DB0-DB7	5	5	5	5	pF max	V = 0 V
\overline{WR} , \overline{CS}	20	20	20	20	pF max	$ \begin{aligned} \mathbf{V}_{\mathrm{IN}} &= 0 \; \mathbf{V} \\ \mathbf{V}_{\mathrm{IN}} &= 0 \; \mathbf{V} \end{aligned} $
SWITCHING CHARACTERISTICS Chip Select to Write Setup Time ⁵ t _{CS}					pr mar	See Timing Diagram $t_{WR} = t_{CS}$
AD7524J, K, L, A, B, C AD7524S, T, U Chip Select to Write Hold Time	170 170	100 100	220 240	130 150	ns min ns min	with CS
t _{CH} All Grades Write Pulse Width	0	0	0	0	ns min	
t _{WR} AD7524J, K, L, A, B, C AD7524S, T, U Data Setup Time	170 170	100 100	220 240	130 150	ns min ns min	$t_{CS} \ge t_{WR}, t_{CH} \ge 0$
t _{DS} AD7524J, K, L, A, B, C AD7524S, T, U Data Hold Time	135 135	60 60	170 170	80 100	ns min ns min	
t _{DH} All Grades	10	10	10	10	ns min	
POWER SUPPLY						
I _{DD}	1 100	2 100	2 500	2 500	mA max μA max	All Digital Inputs $V_{\rm IL}$ or $V_{\rm IH}$ All Digital Inputs 0 V or $V_{\rm DD}$

NOTES

Temperature ranges as follows: J, K, L versions: -40°C to +85°C

A, B, C versions: -40°C to +85°C

S, T, U versions: -55°C to +125°C

Gain error is measured using internal feedback resistor. Full-Scale Range (FSR) = V_{REF}.

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Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted})$

V _{DD} to GND
22
V_{RFB} to GND
V_{REF} to GND
Digital Input Voltage to GND0.3 V to V _{DD} +0.3 V
OUT1, OUT2 to GND0.3 V to V_{DD} +0.3 V

^{*}Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Power Dissipation (Any Package)	
To +75°C	V
Derates above 75°C by 6 mW/°C	С
Operating Temperature	
Commercial (J, K, L)40°C to +85°C	С
Industrial (A, B, C)40°C to +85°C	С
Extended (S, T, U)55°C to +125°C	С
Storage Temperature65°C to +150°C	С
Lead Temperature (Soldering, 10 secs) +300°C	С

CAUTION.

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7524 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



TERMINOLOGY

RELATIVE ACCURACY: A measure of the deviation from a straight line through the end points of the DAC transfer function. Normally expressed as a percentage of full scale range. For the AD7524 DAC, this holds true over the entire V_{REF} range.

RESOLUTION: Value of the LSB. For example, a unipolar converter with n bits has a resolution of (2^{-n}) (V_{REF}). A bipolar converter of n bits has a resolution of $[2^{-(n-1)}]$ [V_{REF}]. Resolution in no way implies linearity.

GAIN ERROR: Gain Error is a measure of the output error between an ideal DAC and the actual device output. It is measured

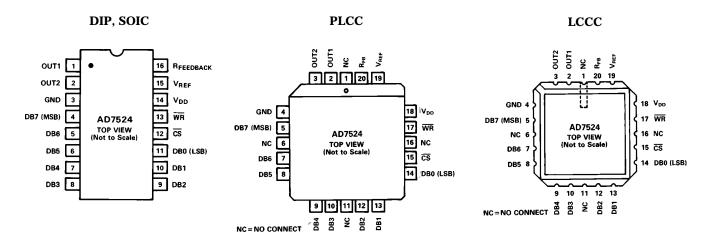
with all 1s in the DAC after offset error has been adjusted out and is expressed in LSBs. Gain Error is adjustable to zero with an external potentiometer.

FEEDTHROUGH ERROR: Error caused by capacitive coupling from V_{REF} to output with all switches OFF.

OUTPUT CAPACITANCE: Capacity from OUT1 and OUT2 terminals to ground.

OUTPUT LEAKAGE CURRENT: Current which appears on OUT1 terminal with all digital inputs LOW or on OUT2 terminal when all inputs are HIGH. This is an error current which contributes an offset voltage at the amplifier output.

PIN CONFIGURATIONS



AD7524

CIRCUIT DESCRIPTION CIRCUIT INFORMATION

The AD7524, an 8-bit multiplying D/A converter, consists of a highly stable thin film R-2R ladder and eight N-channel current switches on a monolithic chip. Most applications require the addition of only an output operational amplifier and a voltage or current reference.

The simplified D/A circuit is shown in Figure 1. An inverted R-2R ladder structure is used—that is, the binarily weighted currents are switched between the OUT1 and OUT2 bus lines, thus maintaining a constant current in each ladder leg independent of the switch state.

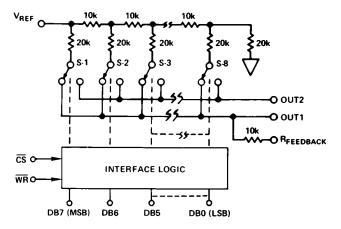


Figure 1. Functional Diagram

EQUIVALENT CIRCUIT ANALYSIS

The equivalent circuit for all digital inputs LOW is shown in Figures 2. In Figure 2 with all digital inputs LOW, the reference current is switched to OUT2. The current source $I_{\rm LEAKAGE}$ is composed of surface and junction leakages to the substrate

while the $\frac{1}{256}$ current source represents a constant 1-bit cur-

rent drain through the termination resistor on the R-2R ladder. The "ON" capacitance of the output N-channel switches is 120 pF, as shown on the OUT2 terminal. The "OFF" switch capacitance is 30 pF, as shown on the OUT1 terminal. Analysis of the circuit for all digital inputs high is similar to Figure 2 however, the "ON" switches are now on terminal OUT1, hence the 120 pF appears at that terminal.

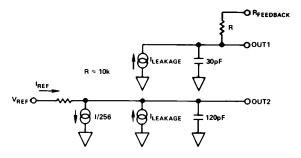


Figure 2. AD7524 DAC Equivalent Circuit—All Digital Inputs Low

INTERFACE LOGIC INFORMATION MODE SELECTION

MODE SELECTION
AD7524 mode selection is controlled by the \overline{CS} and \overline{WR} inputs

WRITE MODE

When $\overline{\text{CS}}$ and $\overline{\text{WR}}$ are both LOW, the AD7524 is in the WRITE mode, and the AD7524 analog output responds to data activity at the DB0-DB7 data bus inputs. In this mode, the AD7524 acts like a nonlatched input D/A converter.

HOLD MODE

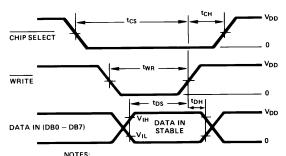
When either $\overline{\text{CS}}$ or $\overline{\text{WR}}$ is HIGH, the AD7524 is in the HOLD mode. The AD7524 analog output holds the value corresponding to the last digital input present at DB0-DB7 prior to $\overline{\text{WR}}$ or $\overline{\text{CS}}$ assuming the HIGH state.

MODE SELECTION TABLE

CS	WR	Mode	DAC Response
L	L	Write	DAC responds to data bus (DB0-DB7) inputs.
Н	X	Hold	Data bus (DB0-DB7) is Locked Out:
X	Н	Hold	DAC holds last data present when WR or CS assumed HIGH state.

L = Low State, H = High State, X = Don't Care.

WRITE CYCLE TIMING DIAGRAM



NOTES: 1. All input signal rise and fall times measured from 10% to 90% of V_{DD} . V_{DD} = +5V, t_r = t_f = 20ns; V_{DD} = +15V, t_r = t_f = 40ns.

2. Timing Measurement Reference level is $\frac{V_{IH} + V_{IL}}{2}$

3. t_{DS} + t_{DH} is approximately constant at 145ns min at +25°C, V_{DD} = +5V and t_{wr} = 170ns min. The AD7524 is specified for a minimum t_{DH} of 10ns, however, in applications where t_{DH} > 10ns, t_{DS} may be reduced accordingly up to the limit t_{DS} = 65ns, t_{DH} = 80ns.

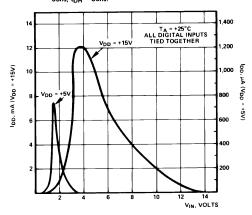


Figure 3. Supply Current vs. Logic Level
Typical plots of supply current, I_{DD} , versus logic input voltage, V_{DD} for $V_{DD} = +5$ V and $V_{DD} = +15$ V are shown above

ANALOG CIRCUIT CONNECTIONS

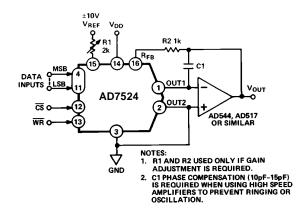


Figure 4. Unipolar Binary Operation (2-Quadrant Multiplication)

Table I. Unipolar Binary Code Table

Digital Input MSB LSB	Analog Output
1111 1111	-V _{REF} (255/256)
1000 0001	$-V_{REF}$ (129/256)
1000 0000	$-V_{REF}$ (128/256) = $-V_{REF}$ /2
0111 1111	$-V_{REF}$ (127/256)
0000 0001	$-V_{REF}$ (1/256)
0000 0000	$-V_{REF}$ (0/256) = 0

Note: 1 LSB = $(2^{-8})(V_{REF}) = 1/256 (V_{REF})$

MICROPROCESSOR INTERFACE

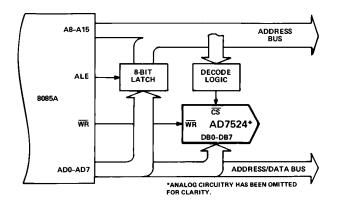


Figure 6. AD7524/8085A Interface

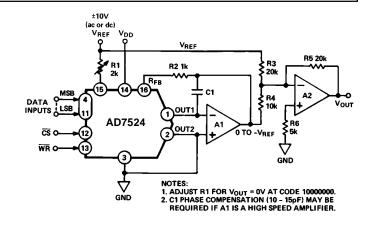


Figure 5. Bipolar (4-Quadrant) Operation

Table II. Bipolar (Offset Binary) Code Table

Analog Output
+V _{REF} (127/128)
$+V_{REF}(1/128)$
0
$-V_{REF}$ (1/128)
$-V_{REF}$ (127/128)
$-V_{REF}$ (128/128)

Note: 1 LSB = $(2^{-7})(V_{REF}) = 1/128 (V_{REF})$

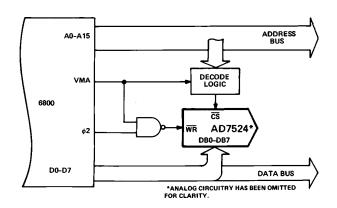


Figure 7. AD7524/MC6800 Interface

POWER GENERATION

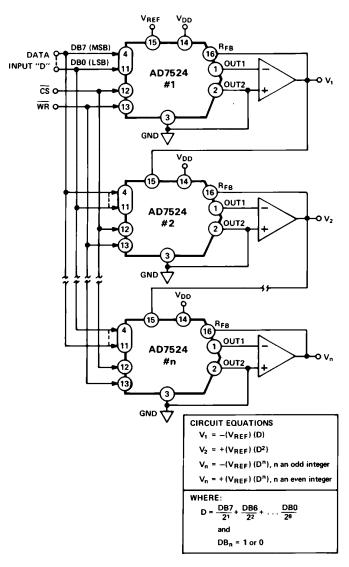
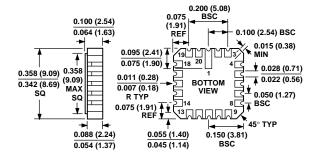


Figure 8.

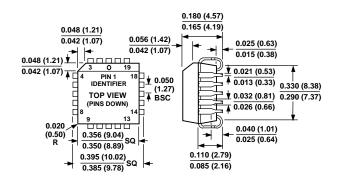
OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

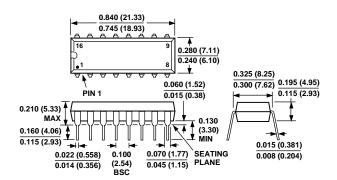
20-Terminal Ceramic Leadless Chip Carrier (E-20A)



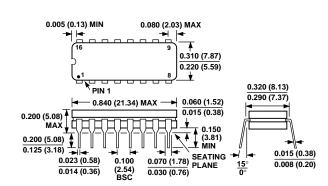
20-Lead Plastic Leadless Chip Carrier (PLCC) (P-20A)



16-Lead Plastic DIP (Narrow) (N-16)



16-Lead Cerdip (Q-16)



16-Lead Narrow-Body (SOIC) (R-16A)

